

STS11NF3LL

N-CHANNEL 30V - 0.008Ω - 11A SO-8 LOW GATE CHARGE STripFET™ II POWER MOSFET

TYPE	V _{DSS}	R _{DS(on)}	I _D
STS11NF3LL	30 V	< 0.011 Ω	11 A

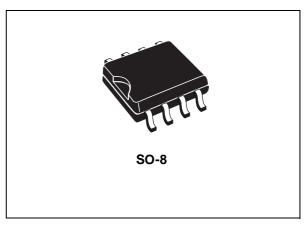
- TYPICAL $R_{DS}(on) = 0.011\Omega @ 4.5V$
- OPTIMAL R_{DS(on)} Q_g TRADE-OFF @4.5V
- CONDUCTION LOSSES REDUCED
- SWITCHING LOSSES REDUCED

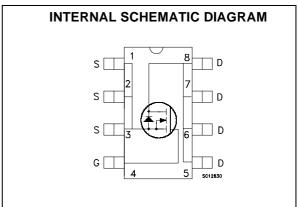


This application specific Power MOSFET is the third genaration of STMicroelectronics unique "Single Feature Size" strip-based process. The resulting transistor shows the best trade-off between on-resistance and gate charge. When used as high and low side in buck regulators, it gives the best performance in terms of both conduction and switching losses. This is extremely important for mother-boards where fast switching and high efficiency are of paramount importance.



 SPECIFICALLY DESIGNED AND OPTIMISED FOR HIGH EFFICIENCY CPU CORE DC/DC CONVERTERS FOR MOBILE PCs





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source Voltage (V _{GS} = 0)	30	V
V_{DGR}	Drain-gate Voltage (R _{GS} = 20 k Ω)	30	V
V _{GS}	Gate- source Voltage	± 16	V
I _D	Drain Current (continuos) at T _C = 25°C (*) Drain Current (continuos) at T _C = 100°C	11 7	A A
I _{DM} (●)	Drain Current (pulsed)	44	Α
P _{TOT}	Total Dissipation at T _C = 25°C	2.5	W

⁽ Pulse width limited by safe operating area

(*)Value limited by wires bonding

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THERMAL DATA

Rthj-amb	Thermal Resistance Junction-ambient Max (#)	50	°C/W
Tj	Max. Operating Junction Temperature	150	°C
T _{stg}	Storage Temperature	-65 to 150	°C

^(#) When Mounted on a 1inch² pad

ELECTRICAL CHARACTERISTICS ($T_{CASE} = 25~^{\circ}C$ UNLESS OTHERWISE SPECIFIED) OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0$	30			V
I _{DSS}	Zero Gate Voltage	V _{DS} = Max Rating			1	μA
	Drain Current (V _{GS} = 0)	V _{DS} = Max Rating, T _C = 125 °C			10	μΑ
I _{GSS}	Gate-body Leakage Current (V _{DS} = 0)	V _{GS} = ± 16V			±100	nA

ON (1)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			V
R _{DS(on)}	Static Drain-source On	V _{GS} = 10 V, I _D = 5.5 A		0.008	0.011	Ω
	Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 5.5 \text{ A}$		0.011	0.013	Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g _{fs} (1)	Forward Transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max},$ $I_{D} = 5.5 \text{ A}$		15		S
C _{iss}	Input Capacitance	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0$		1700		pF
Coss	Output Capacitance			505		pF
C _{rss}	Reverse Transfer Capacitance			115		pF

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ELECTRICAL CHARACTERISTICS (CONTINUED)

SWITCHING ON

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on Delay Time	V _{DD} = 15 V, I _D = 5.5 A		20		ns
t _r	Rise Time	$R_G = 4.7\Omega V_{GS} = 4.5 V$ (Resistive Load, see Fig. 3)		70		ns
Q _g Q _{gs} Q _{gd}	Total Gate Charge Gate-Source Charge Gate-Drain Charge	V _{DD} = 15 V, I _D = 11 A, V _{GS} = 4.5 V		21 9.5 10	28	nC nC nC

SWITCHING OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(off)}	Turn-off-Delay Time Fall Time	$V_{DD} = 15 \text{ V}, I_D = 5.5 \text{ A},$		40 20		ns
Lf	Fall Tillie	$R_G = 4.7\Omega$, $V_{GS} = 4.5 V$ (Resistive Load see, Fig. 3)		20		ns

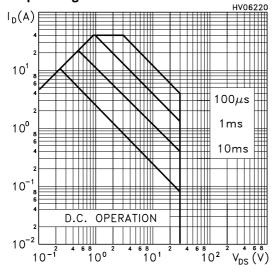
SOURCE DRAIN DIODE

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain Current				11	Α
I _{SDM} (1)	Source-drain Current (pulsed)				44	Α
V _{SD} (2)	Forward On Voltage	I _{SD} = 11 A, V _{GS} = 0			1.2	V
t _{rr} Q _{rr} I _{RRM}	Reverse Recovery Time Reverse Recovery ChargeReverse Recovery Current	$I_{SD} = 11 \text{ A}, \text{ di/dt} = 100 \text{A/µs},$ $V_{DD} = 20 \text{ V}, T_j = 150 ^{\circ}\text{C}$ (see test circuit, Figure 5)		45 52 2.3		ns nC A

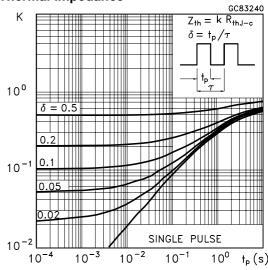
Note: 1. Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %.

2. Pulse width limited by safe operating area.

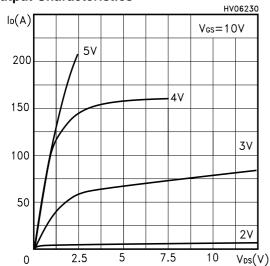
Safe Operating Area



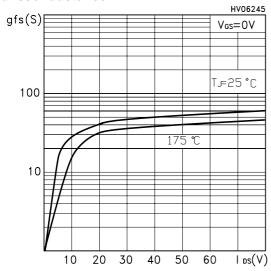
Thermal Impedance



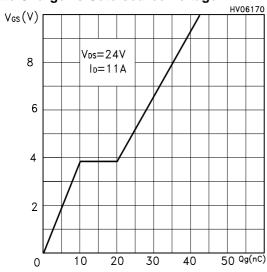
Output Characteristics



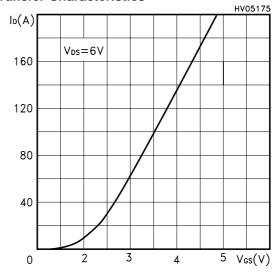
Transconductance



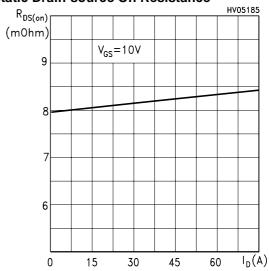
Gate Charge vs Gate-source Voltage



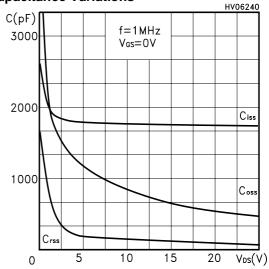
Transfer Characteristics



Static Drain-source On Resistance

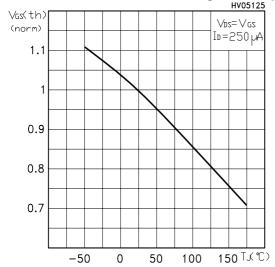


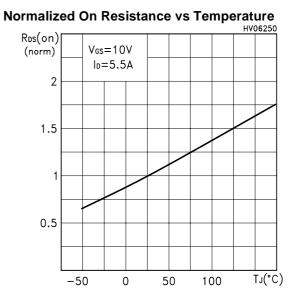
Capacitance Variations



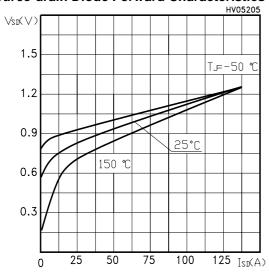
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Normalized Gate Thereshold Voltage vs Temp. HV05125





Source-drain Diode Forward Characteristics



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Fig. 1: Unclamped Inductive Load Test Circuit

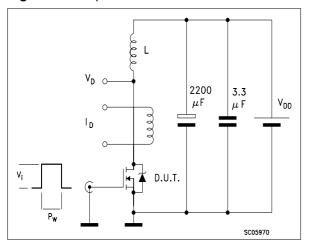


Fig. 3: Switching Times Test Circuit For Resistive Load

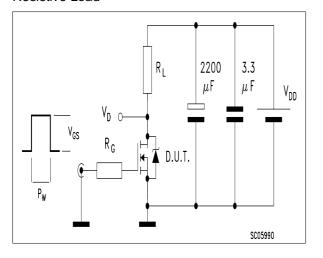


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times

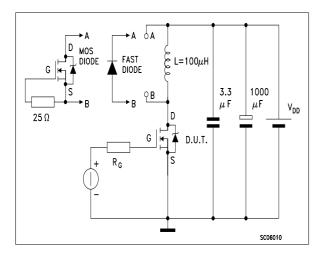


Fig. 2: Unclamped Inductive Waveform

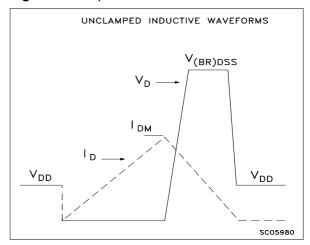
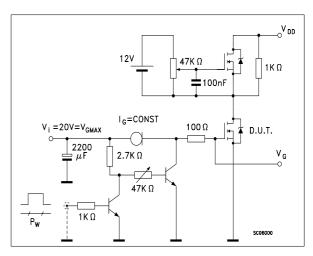


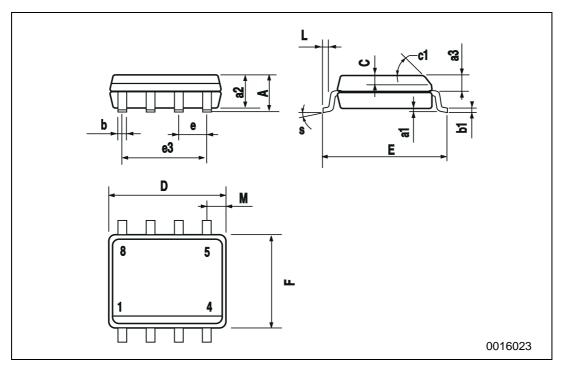
Fig. 4: Gate Charge test Circuit



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SO-8 MECHANICAL DATA

DIM.		mm			inch	
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45	(typ.)		
D	4.8		5.0	0.188		0.196
Е	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S			8 (1	max.)		



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